Preferred Device

Silicon Controlled Rectifiers Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supplies.

Features

- Glass Passivated Junctions with Center Gate Geometry for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Blocking Voltage to 800 V
- Pb–Free Packages are Available*

MAXIMUM RATINGS[†] (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
$\begin{array}{l} \mbox{Peak Repetitive Off-State Voltage (Note 1)} \\ (T_J = -40 \mbox{ to } 125^\circ \mbox{C}, \mbox{ Sine Wave}, \\ 50 \mbox{ to } 60 \mbox{ Hz}, \mbox{ Gate Open}) & 2N6394 \\ & 2N6395 \\ & 2N6397 \\ & 2N6399 \end{array}$	Vdrm, Vrrm	50 100 400 800	V
On-State RMS Current (180° Conduction Angles; T _C = 90°C)	I _{T(RMS)}	12	A
Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, $T_J = 90^{\circ}C$)	I _{TSM}	100	A
Circuit Fusing (t = 8.3 ms)	l ² t	40	A ² s
Forward Peak Gate Power (Pulse Width \leq 1.0 µs, T _C = 90°C)	P _{GM}	20	W
Forward Average Gate Power (t = 8.3 ms, T_C = 90°C)	P _{G(AV)}	0.5	W
Forward Peak Gate Current (Pulse Width \leq 1.0 µs, T _C = 90°C)	I _{GM}	2.0	A
Operating Junction Temperature Range	Τ _J	-40 to +125	°C
Storage Temperature Range	T _{stg}	-40 to +150	°C

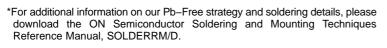
MAXIMUM RATINGS[†] (T_J = 25°C unless otherwise noted)

Rating	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.0	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	ΤL	260	°C

†Indicates JEDEC Registered Data

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

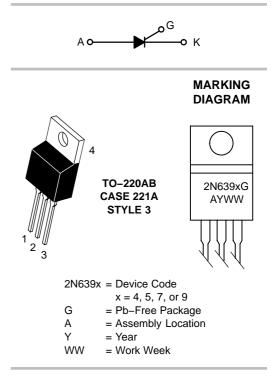




ON Semiconductor®

http://onsemi.com

SCRs 12 AMPERES RMS 50 thru 800 VOLTS



	PIN ASSIGNMENT
1	Cathode
2	Anode
3	Gate
4	Anode

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

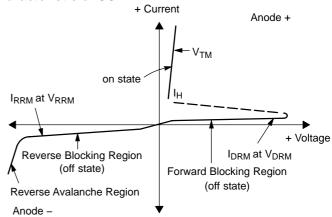
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS	•				
†Peak Repetitive Forward or Reverse Blocking Current $(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM}, \text{ Gate Open})$ $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ T_J = 125^{\circ}C		-	-	10 2.0	μA mA
ON CHARACTERISTICS		1			l
†Peak Forward On-State Voltage (Note 2) (I _{TM} = 24 A Peak)	V _{TM}	-	1.7	2.2	V
†Gate Trigger Current (Continuous dc) (V_D = 12 Vdc, R_L = 100 Ohms)	I _{GT}	-	5.0	30	mA
†Gate Trigger Voltage (Continuous dc) (V_D = 12 Vdc, R_L = 100 Ohms)	V _{GT}	-	0.7	1.5	V
Gate Non–Trigger Voltage (V _D = 12 Vdc, R _L = 100 Ohms, T _J = 125°C)	V _{GD}	0.2	-	-	V
†Holding Current (V _D = 12 Vdc, Initiating Current = 200 mA, Gate Open)	Ι _Η	-	6.0	50	mA
Turn-On Time (I_{TM} = 12 A, I_{GT} = 40 mAdc, V_D = Rated V_{DRM})	t _{gt}	-	1.0	2.0	μS
Turn-Off Time (V_D = Rated V_{DRM}) (I_{TM} = 12 A, I_R = 12 A (I_{TM} = 12 A, I_R = 12 A, I_J = 125°C) t _q	-	15 35		μs
DYNAMIC CHARACTERISTICS					
Critical Rate-of-Rise of Off-State Voltage Exponential $(V_D = Rated V_{DRM}, T_J = 125^{\circ}C)$		-	50	-	V/μs

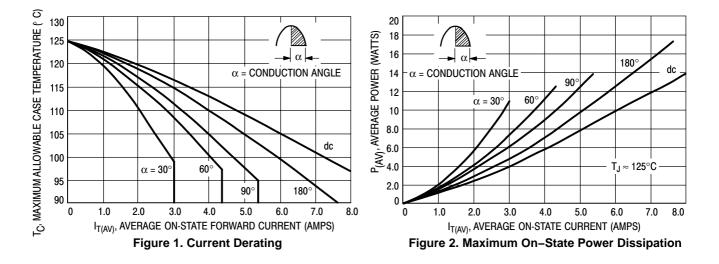
†Indicates JEDEC Registered Data

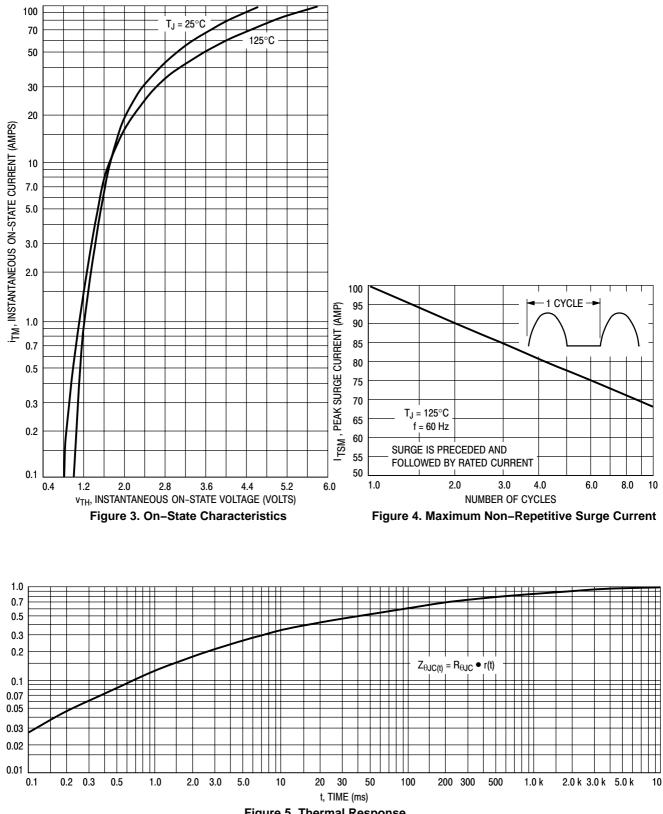
2. Pulse Test: Pulse Width \leq 300 µsec, Duty Cycle \leq 2%.

Symbol	Parameter
V _{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Peak On State Voltage
Ι _Η	Holding Current

Voltage Current Characteristic of SCR







TYPICAL CHARACTERISTICS

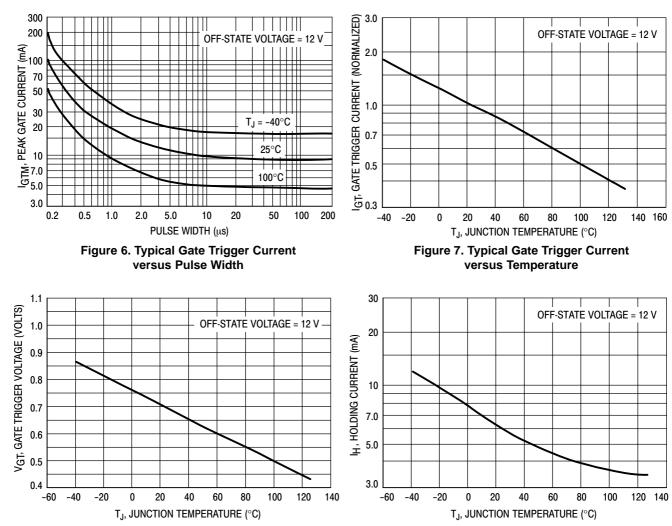


Figure 8. Typical Gate Trigger Voltage versus Temperature



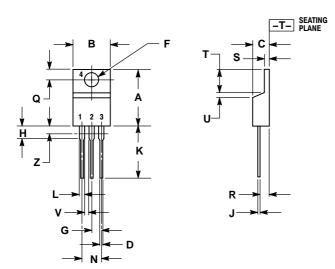
ORDERING INFORMATION

Device	Package	Shipping**
2N6394	TO-220AB	500 Units / Bulk
2N6394G	TO-220AB (Pb-Free)	500 Units / Bulk
2N6395	TO-220AB	500 Units / Bulk
2N6395G	TO-220AB (Pb-Free)	500 Units / Bulk
2N6397	TO-220AB	500 Units / Bulk
2N6397G	TO-220AB (Pb-Free)	500 Units / Bulk
2N6399	TO-220AB	500 Units / Bulk
2N6399G	TO-220AB (Pb-Free)	500 Units / Bulk

**For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 ISSUE AD



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982.
CONTROLLING DIMENSION: INCH.
DIMENSION Z DEFINES A ZONE WHERE ALL

 DIMENSION Z DEFINES A ZONE WHERE ALI BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Η	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
×	0.045		1.15	
Ζ		0.080		2.04

2. ANODE

GATE
ANODE

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